Product data sheet

1. General description

The 74AHC30; 74AHCT30 is a high-speed Si-gate CMOS device and is pin compatible with Low-power Schottky TTL (LSTTL). It is specified in compliance with JEDEC standard No. 7-A.

The 74AHC30; 74AHCT30 provides an 8-input NAND function.

2. Features and benefits

- · Balanced propagation delays
- · All inputs have Schmitt-trigger actions
- Inputs accept voltages higher than V_{CC}
- Input levels:
 - For 74AHC30: CMOS level
 - For 74AHCT30: TTL level
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- · Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74AHC30D 74AHCT30D	-40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74AHC30PW 74AHCT30PW	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
74AHC30BQ 74AHCT30BQ	-40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm	SOT762-1
74AHC30GU12	-40 °C to +125 °C	XQFN12	plastic, extremely thin quad flat package; no leads; 12 terminals; body 1.70 × 2.0 × 0.50 mm	SOT1174-1



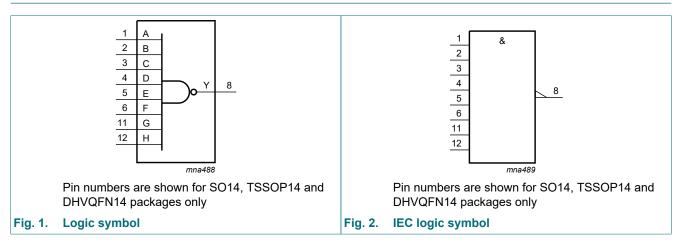
4. Marking

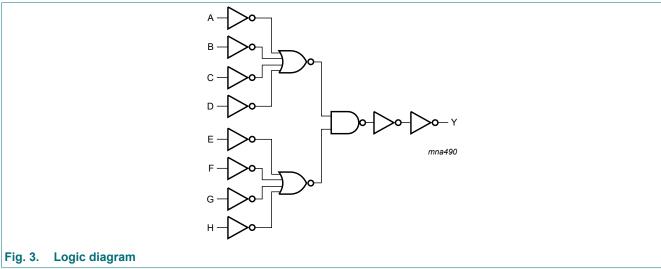
Table 2. Marking codes

Type number	Marking
74AHC30D	74AHC30D
74AHCT30D	74AHCT30D
74AHC30PW	AHC30
74AHCT30PW	AHCT30
74AHC30BQ	AHC30
74AHCT30BQ	AHT30
74AHC30GU12	A3 [1]

^[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

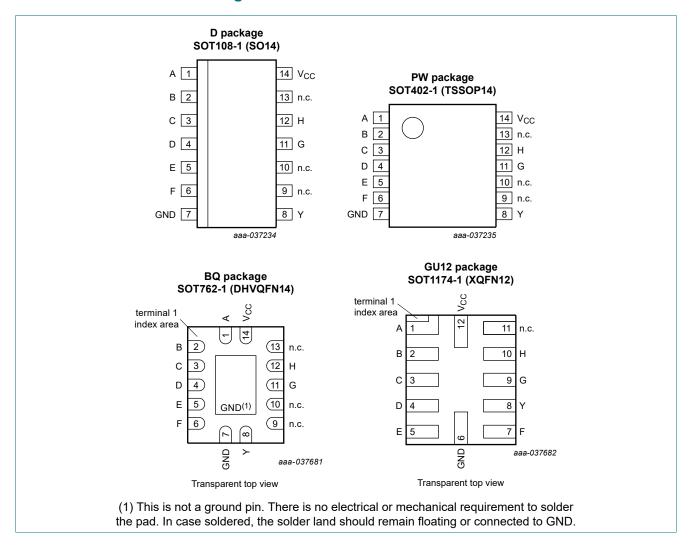
5. Functional diagram





6. Pinning information

6.1. Pinning



6.2. Pin description

Table 3. Pin description

Symbol	Pin		Description
	SO14, TSSOP14 and DHVQFN14	XQFN12	
A	1	1	data input
В	2	2	data input
С	3	3	data input
D	4	4	data input
E	5	5	data input
F	6	7	data input
GND	7	6	ground (0 V)
Υ	8	8	data output
n.c.	9	-	not connected
n.c.	10	-	not connected
G	11	9	data input
Н	12	10	data input
n.c.	13	11	not connected
V _{CC}	14	12	supply voltage

7. Functional description

Table 4. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care.

Input								Output
Α	В	С	D	E	F	G	Н	Υ
L	Х	Х	Х	Х	X	Х	Х	Н
X	L	Х	Х	Х	Х	Х	Х	Н
Х	X	L	Х	Х	Х	Х	Х	Н
Х	X	Х	L	Х	Х	Х	Х	Н
Х	X	Х	X	L	X	Х	Х	Н
Х	X	Х	Х	X	L	Х	Х	Н
Х	X	X	Х	X	X	L	Х	Н
X	Х	Х	Х	X	X	Х	L	Н
Н	Н	Н	Н	Н	Н	Н	Н	L

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7.0	V
VI	input voltage			-0.5	+7.0	V
I _{IK}	input clamping current	V _I < -0.5 V	[1]	-20	-	mA
I _{OK}	output clamping current	V_{O} < -0.5 V or V_{O} > V_{CC} + 0.5 V	[1]	-20	+20	mA
Io	output current	$V_{O} = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$		-25	+25	mA
I _{CC}	supply current			-	+75	mA
I _{GND}	ground current			-75	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C				
		SOT108-1 (SO14) SOT402-1 (TSSOP14) SOT762-1 (DHVQFN14)	[2]	-	500	mW
		SOT1174-1 (XQFN12)		-	250	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		74AHC30)	7	Unit		
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	5.5	4.5	5.0	5.5	V
VI	input voltage output voltage		0	-	5.5	0	-	5.5	V
Vo			0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$	-	-	100	-	-	-	ns/V
	and fall rate	$V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$	-	-	20	-	-	20	ns/V

^[2] For SOT108-1 (SO14) package: P_{tot} derates linearly with 10.1 mW/K above 100 °C. For SOT402-1 (TSSOP14) package: P_{tot} derates linearly with 7.3 mW/K above 81 °C. For SOT762-1 (DHVQFN14) package: P_{tot} derates linearly with 9.6 mW/K above 98 °C.

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	Unit	
			Min	Тур	Max	Min	Max	Min	Max	
74AHC3	0							'	-	
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	-	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 3.0 V	2.1	-	-	2.1	-	2.1	-	V
		V _{CC} = 5.5 V	3.85	-	-	3.85	-	3.85	-	V
V _{IL}			-	-	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 3.0 V	-	-	0.9	-	0.9	-	0.9	V
		V _{CC} = 5.5 V	-	-	1.65	-	1.65	-	1.65	V
V _{OH}	HIGH-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = -50 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I _O = -50 μA; V _{CC} = 3.0 V	2.9	3.0	-	2.9	-	2.9	-	V
		I _O = -50 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -4.0 mA; V _{CC} = 3.0 V	2.58	-	-	2.48	-	2.40	-	V
		I _O = -8.0 mA; V _{CC} = 4.5 V	3.94	-	-	3.80	-	3.70	-	V
V _{OL}	LOW-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = 50 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 50 μA; V _{CC} = 3.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 50 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 3.0 V	-	-	0.36	-	0.44	-	0.55	V
		I _O = 8.0 mA; V _{CC} = 4.5 V	-	-	0.36	-	0.44	-	0.55	V
l _l	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	2.0	-	20	-	40	μΑ
Cı	input capacitance	V _I = V _{CC} or GND	-	3	10	-	10	-	10	pF
C _O	output capacitance		-	4	-	-	-	-	-	pF

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Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74AHCT	30							<u>'</u>	<u>'</u>	
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	-	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 V$								
	output voltage	Ι _Ο = -50 μΑ	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -8.0 mA	3.94	-	-	3.80	-	3.70	-	V
V _{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 V$								
output volta		Ι _Ο = 50 μΑ	-	0	0.1	-	0.1	-	0.1	V
		I _O = 8.0 mA	-	-	0.36	-	0.44	-	0.55	V
l _l	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	2.0	-	20	-	40	μΑ
ΔI _{CC}	additional supply current $ \begin{array}{c} \text{per input pin;} \\ V_I = V_{CC} - 2.1 \text{ V; other pins} \\ \text{at } V_{CC} \text{ or GND; } I_O = 0 \text{ A;} \\ V_{CC} = 4.5 \text{ V to } 5.5 \text{ V} \end{array} $		-	-	1.35	-	1.5	-	1.5	mA
C _I	input capacitance	V _I = V _{CC} or GND	-	3	10	-	10	-	10	pF
Co	C _O output capacitance		-	4	-	-	-	-	-	pF

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11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 5.

		·=									
Symbol	Parameter	Conditions			25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	Min	Max	
74AHC3	0				<u>'</u>		,	,	,	'	<u>'</u>
t _{pd}	propagation	A, B, C, D, E, F, G, H to Y	; see	Fig. 4	and Fig	<u>. 5</u> [2]					
	delay	V _{CC} = 3.0 V to 3.6 V									
		C _L = 15 pF		-	5.0	9.5	1.0	11.0	1.0	12.0	ns
		C _L = 50 pF		-	6.7	12.0	1.0	14.5	1.0	15.5	ns
		V _{CC} = 4.5 V to 5.5 V									
		C _L = 15 pF		-	3.6	6.5	1.0	7.5	1.0	8.0	ns
		C _L = 50 pF		-	4.9	8.0	1.0	9.5	1.0	10.5	ns
C _{PD}	power dissipation capacitance	$f_i = 1 \text{ MHz};$ $V_I = \text{GND to } V_{CC}$	[3]	-	10	-	-	-	-	-	pF
74AHCT	30; V _{CC} = 4.5	V to 5.5 V			•						
t _{pd}	propagation	A, B, C, D, E, F, G, H to Y	; see	Fig. 4	and Fig	<u>. 5</u> [2]					
	delay	C _L = 15 pF		-	3.3	6.5	1.0	7.5	1.0	8.0	ns
		C _L = 50 pF		-	4.7	8.5	1.0	9.5	1.0	10.5	ns
C _{PD}	power dissipation capacitance	$f_i = 1 \text{ MHz};$ $V_I = \text{GND to } V_{CC}$	[3]	-	12	-	-	-	-	-	pF

Typical values are measured at nominal supply voltage ($V_{CC} = 3.3 \text{ V}$ and $V_{CC} = 5.0 \text{ V}$).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$$
 where:

f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

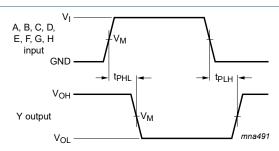
V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_0)$ = sum of the outputs.

 t_{pd} is the same as t_{PLH} and t_{PHL} . C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

11.1. Waveforms



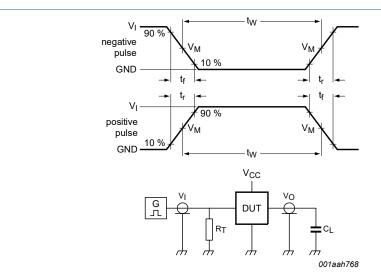
Measurement points are given in Table 9.

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 4. Input to output propagation delays

Table 9. Measurement points

Туре	Input	Output
	V _M	V _M
74AHC30	0.5 × V _{CC}	0.5 × V _{CC}
74AHCT30	1.5 V	0.5 × V _{CC}



Test data is given in Table 10.

Definitions for test circuit:

 R_T = termination resistance should be equal to the output impedance Z_0 of the pulse generator;

 C_L = load capacitance including jig and probe capacitance.

Fig. 5. Test circuit for measuring switching times

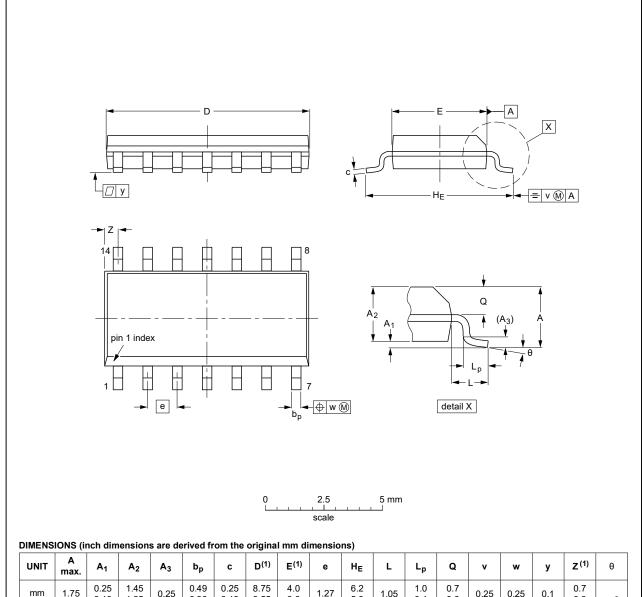
Table 10. Test data

Туре	Input		Load	Test
	VI	t _r , t _f	C _L	
74AHC30	V _{CC}	≤ 3.0 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}
74AHCT30	3.0 V ≤ 3.0 ns		15 pF, 50 pF	t _{PLH} , t _{PHL}

12. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



UNIT	A max.	A ₁	A ₂	A ₃	b _p	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.35 0.34	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

Note

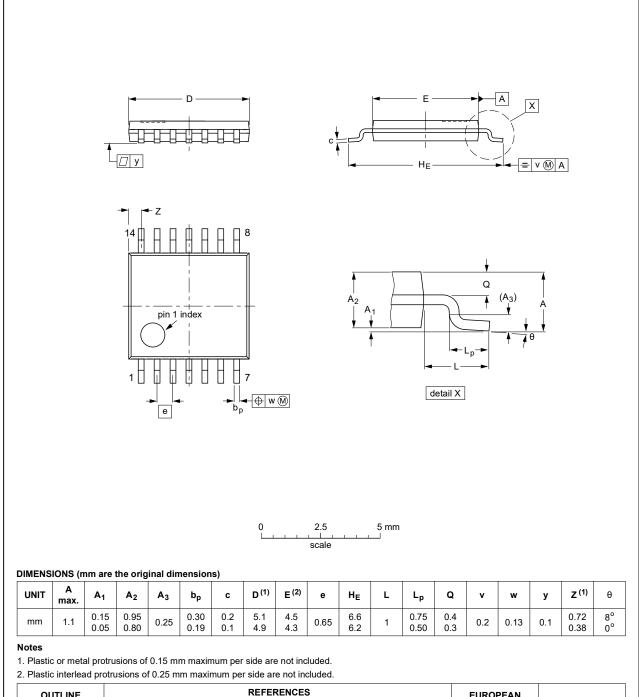
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT108-1	076E06	MS-012			99-12-27 03-02-19

Fig. 6. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



OUTLINE		REFERENCES			EUROPEAN ISSUE DAT	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT402-1		MO-153				99-12-27 03-02-18

Fig. 7. Package outline SOT402-1 (TSSOP14)

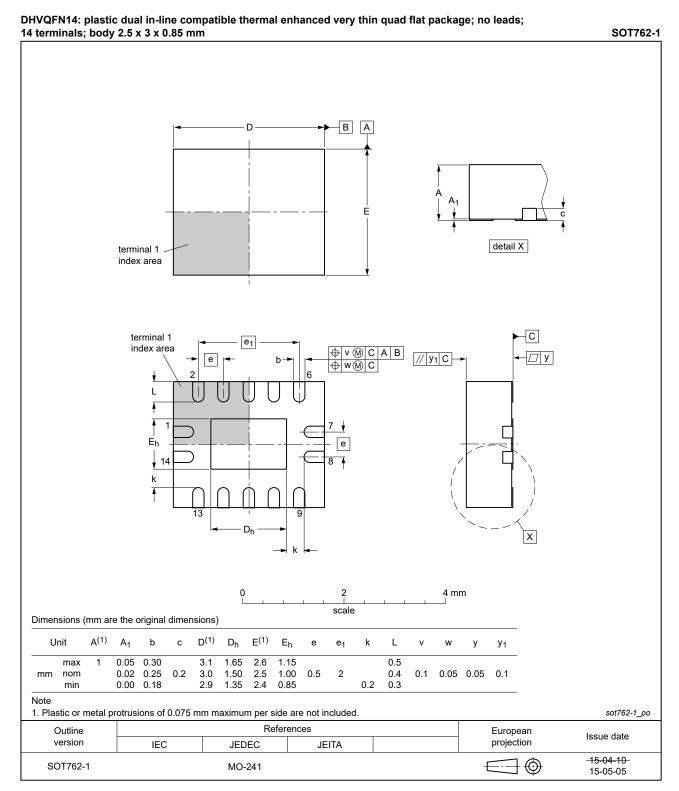


Fig. 8. Package outline SOT762-1 (DHVQFN14)

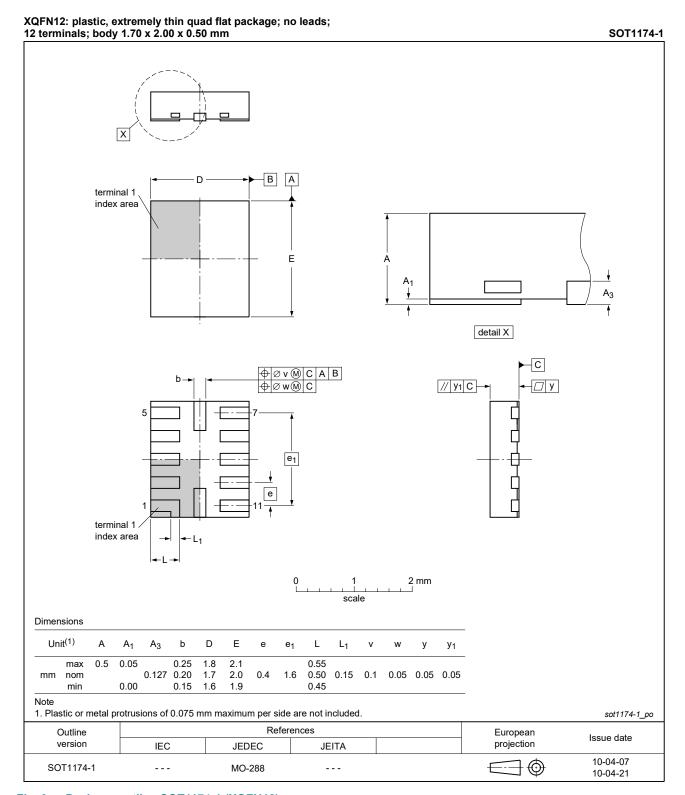


Fig. 9. Package outline SOT1174-1 (XQFN12)

13. Abbreviations

Table 11. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
LSTTL	Low-power Schottky Transistor-Transistor Logic

14. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AHC_AHCT30 v.6	20231009	Product data sheet	-	74AHC_AHCT30 v.5
Modifications:	Section 2: E	SD specification updated a	according to the la	itest JEDEC standard.
74AHC_AHCT30 v.5	20200506	Product data sheet	-	74AHC_AHCT30 v.4
Modifications:	guidelines o Legal texts I	of this data sheet has been if Nexperia. have been adapted to the r rating values for P _{tot} total p	new company nan	ne where appropriate.
74AHC_AHCT30 v.4	20150722	Product data sheet	-	74AHC_AHCT30 v.3
Modifications:	 Added type 	number 74AHC30GU12.		
74AHC_AHCT30 v.3	20090626	Product data sheet	-	74AHC_AHCT30 v.2
Modifications:	• <u>Section 8</u> : d	DHVQFN14 package addec erating values added for D outline drawing added for I	HVQFN14 packa	-
74AHC_AHCT30 v.2	20080530	Product data sheet	-	74AHC_AHCT30 v.1
74AHC_AHCT30 v.1	19991130	Product specification	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

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